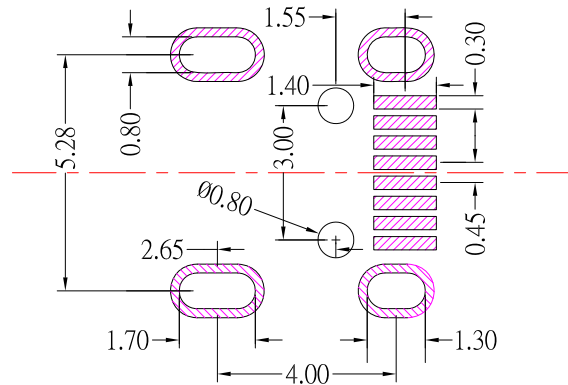
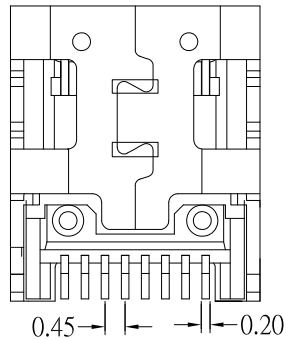


P.C.B LAYOUT MOUNTING PATTERN



SPECIFICATIONS

Electrical:

- 1.Current Rating: 1.0A / contact terminal
- 2.Voltage Rating: 30V DC
- 3.Contact Resistance: 50 milliohms Max
- 4.Dielectric Withstanding Voltage:
300 V AC AT Sec Level
- 5.Insulation Resistance: 1,000 MEGA ohms Min

Mechanical:

- 1.Connector Mate and Unmate Force
Mate force: 3.0 kgf (Max)
Unmate force: 0.7 kgf (Min)
- 2.Terminal Retention: 0.5 kgf (Min)

Material:

- 1.Housing:
High Temperature Thermal Plastics,
UL 94V-0 , LCP , Black
- 2.Contact: PHOSPHOR BRONZE
- 3.Shell: BRASS

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls
Nickel under plated overall
- 2.Shell: Gold Plating

4	更新鏡層	Jack	102813
3	更新為A0版	Jack	092413
2	新增外殼腳尺寸	Jack	080713
1	更新SPEC	Jack	041113
ITEM NO.	DESCRIPTION	DRAWN	DATE

東莞市高迪電子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD. ANGEL'S

UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	10/28/13			
CHECKED BY:	DATE	FINISH	MODLE	MINI USB 8P/F DIP 4 腳長, 外殼鍍金
Jacky Chen	10/28/13			
APPROVED BY:	DATE	SCALE	DWG NO.	MUSB-8B-D-G-S175
Tony Kao	10/28/13	1 : 1	PART NO.	MUSB-8B-D-G-S175
		SHEET NO.	1 of 1	
				SIZE A4
				VER A1